

N-Channel Super Junction Power MOSFET III

General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent R_{DS(ON)} with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

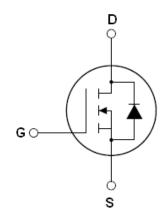
Features

- New technology for high voltage device
- ●Low on-resistance and low conduction losses
- ●Small package
- Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ●ROHS compliant

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

| V _{DS} @T _{jmax} | 710 | V |
|------------------------------------|-----|---|
| R _{DS(ON)} TYP | 2.2 | Ω |
| I_D | 2 | A |



Schematic diagram

Package Marking And Ordering Information

| Device | Device Package | Marking |
|------------|----------------|------------|
| NCE65T2K4I | TO-251 | NCE65T2K4I |
| NCE65T2K4K | TO-252 | NCE65T2K4K |





TO-251

TO-252

Table 1. Absolute Maximum Ratings (T_c=25℃)

| Parameter | Symbol | Value | Unit |
|---|-------------------------|-------|------|
| Drain-Source Voltage (VGS=0V) | V _{DS} | 650 | V |
| Gate-Source Voltage (V _{DS} =0V) ,AC (f>1 Hz) | V _G s | ±30 | V |
| Continuous Drain Current at Tc=25°C | I _{D (DC)} | 2 | Α |
| Continuous Drain Current at Tc=100°C | I _{D (DC)} | 1.25 | Α |
| Pulsed drain current (Note 1) | I _{DM} (pluse) | 8 | Α |
| Maximum Power Dissipation(Tc=25℃) | P _D | 21 | W |
| Derate above 25°C | | 0.168 | W/°C |
| Single pulse avalanche energy (Note2) | Eas | 12 | mJ |
| Avalanche current ^(Note 1) | I _{AR} | 0.3 | А |
| Repetitive Avalanche energy , t_{AR} limited by T_{jmax} (Note 1) | E _{AR} | 0.06 | mJ |



| Parameter | Symbol | Value | Unit |
|---|------------------|---------|------|
| Drain Source voltage slope, V _{DS} ≤480 V, | dv/dt | 50 | V/ns |
| Reverse diode dv/dt, $V_{DS} \leq 480 \text{ V,I}_{SD} < I_{D}$ | dv/dt | 15 | V/ns |
| Operating Junction and Storage Temperature Range | T_{J}, T_{STG} | -55+150 | °C |

Table 2. Thermal Characteristic

| Parameter | Symbol | Value | Unit |
|---|-------------------|-------|-------|
| Thermal Resistance, Junction-to-Case (Maximum) | R _{thJC} | 5.95 | °C /W |
| Thermal Resistance, Junction-to-Ambient (Maximum) | R _{thJA} | 75 | °C /W |

Table 3. Electrical Characteristics (TA=25°Cunless otherwise noted)

| Table 3. Liectifical Characteristics | 25 (TA-23 Curiless otherwise noted) | | | | | |
|--|-------------------------------------|---|-----|------|------|------|
| Parameter | Symbol | Condition | Min | Тур | Max | Unit |
| On/off states | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V I _D =250μA | 650 | | | V |
| Zero Gate Voltage Drain Current(Tc=25°C) | I _{DSS} | V _{DS} =650V,V _{GS} =0V | | | 1 | μA |
| Zero Gate Voltage Drain Current(Tc=125℃) | I _{DSS} | V _{DS} =650V,V _{GS} =0V | | | 10 | μA |
| Gate-Body Leakage Current | I _{GSS} | V _{GS} =±20V,V _{DS} =0V | | | ±100 | nA |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}$, $I_{D}=70\mu A$ | 3 | 3.5 | 4 | V |
| Drain-Source On-State Resistance | R _{DS(ON)} | V _{GS} =10V, I _D =1A | | 2200 | 2400 | mΩ |
| Dynamic Characteristics | | | | | | |
| Input Capacitance | C _{lss} | \/ -50\/\/ -0\/ | | 120 | | PF |
| Output Capacitance | Coss | V_{DS} =50V, V_{GS} =0V, F=1.0MHz | | 8 | | PF |
| Reverse Transfer Capacitance | C _{rss} | F=1.UIVID2 | | 0.2 | | PF |
| Total Gate Charge | Qg | \/ -400\/ L -24 | | 3.5 | 10 | nC |
| Gate-Source Charge | Q _{gs} | V_{DS} =480V, I_{D} =2A, V_{GS} =10V | | 0.9 | | nC |
| Gate-Drain Charge | Q_{gd} | V _{GS} -10V | | 1.8 | | nC |
| Switching times | | | • | | | |
| Turn-on Delay Time | t _{d(on)} | | | 10 | | nS |
| Turn-on Rise Time | t _r | V _{DD} =380V,I _D =1A, | | 9 | | nS |
| Turn-Off Delay Time | t _{d(off)} | R_G =10 Ω , V_{GS} =10 V | | 56 | | nS |
| Turn-Off Fall Time | t _f | | | 11 | | nS |
| Source- Drain Diode Characteristics | | | | | | |
| Source-drain current(Body Diode) | I _{SD} | T -25°C | | | 2 | Α |
| Pulsed Source-drain current(Body Diode) | I _{SDM} | T _C =25°C | | | 8 | Α |
| Forward On Voltage | V_{SD} | Tj=25°C,I _{SD} =2A,V _{GS} =0V | | 1 | 1.3 | V |
| Reverse Recovery Time | t _{rr} | | | 170 | | nS |
| Reverse Recovery Charge | Q _{rr} | Tj=25°C,I _F =1A,di/dt=100A/µs | | 0.26 | | uC |
| Peak reverse recovery current | I _{rrm} | | | 3 | | Α |
| · | | | | | | |

Notes: 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25°C,VDD=50V,VG=10V, R_G=25 Ω



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Safe operating area

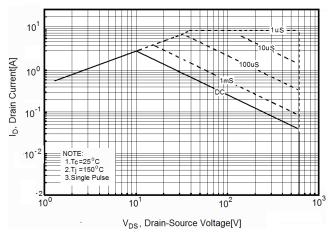


Figure 3. Output characteristics

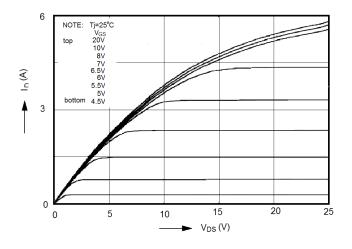


Figure 5. Static drain-source on resistance

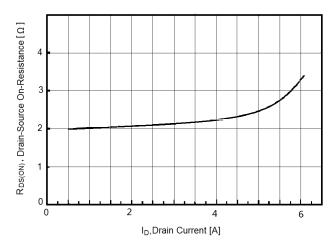


Figure 2. Source-Drain Diode Forward Voltage

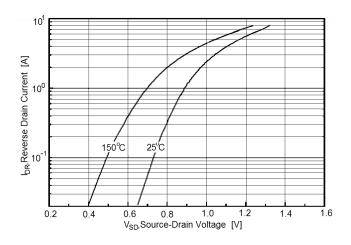


Figure 4. Transfer characteristics

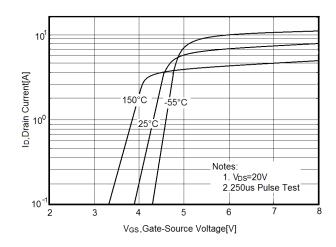


Figure 6. R_{DS(ON)} vs Junction Temperature

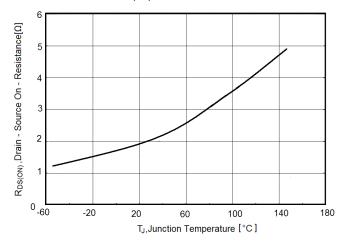




Figure 7. BV_{DSS} vs Junction Temperature

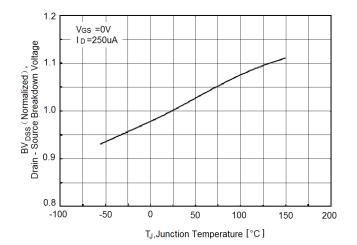


Figure 8. Maximum I_D vs Junction Temperature

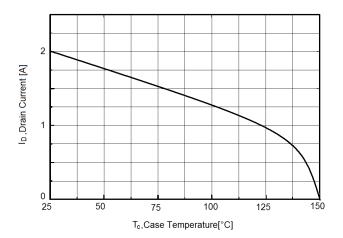
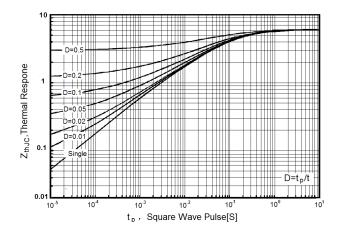


Figure 9. Transient Thermal Impedance

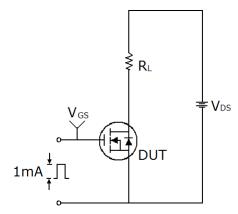


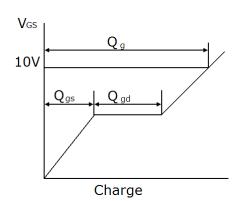




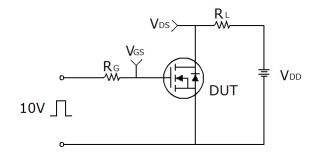
Test circuit

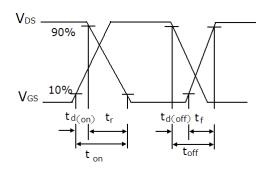
1) Gate charge test circuit & Waveform



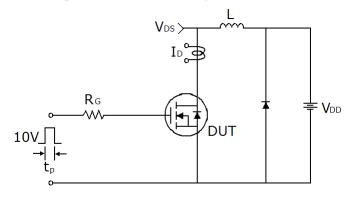


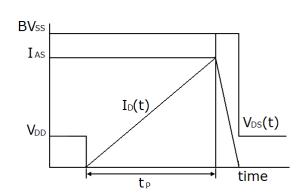
2) Switch Time Test Circuit:





3) Unclamped Inductive Switching Test Circuit & Waveforms

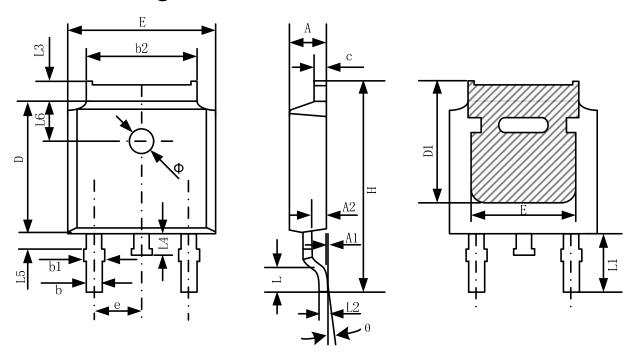








TO-252-2 Package Information

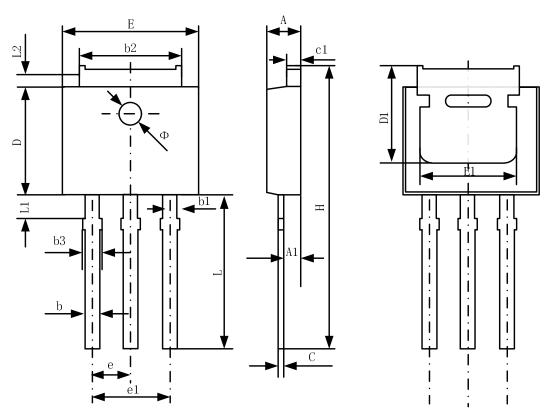


| C. mah al | Dimensions | In Millimeters | Dimensions In Inches | | |
|-----------|------------|----------------|----------------------|-------|--|
| Symbol | Min. | Max. | Min. | Max. | |
| А | 2.20 | 2.38 | 0.087 | 0.094 | |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 | |
| A2 | 0.90 | 1.10 | 0.035 | 0.043 | |
| b | 0.72 | 0.85 | 0.028 | 0.033 | |
| b1 | 0.72 | 0.90 | 0.028 | 0.035 | |
| b2 | 5.13 | 5.46 | 0.202 | 0.215 | |
| С | 0.47 | 0.60 | 0.019 | 0.024 | |
| D | 6.00 | 6.20 | 0.236 | 0.244 | |
| D1 | 5.25 | | 0.207 | | |
| E | 6.50 | 6.70 | 0.256 | 0.264 | |
| E1 | 4.70 | | 0.185 | | |
| e | 2.19 | 2.39 | 0.086 | 0.094 | |
| Н | 9.80 | 10.40 | 0.386 | 0.409 | |
| L | 1.40 | 1.70 | 0.055 | 0.067 | |
| L1 | 2.90 | REF | 0.114 | REF | |
| L2 | 0.50 | 8 BSC | 0.020 BSC | | |
| L3 | 0.90 | 1.25 | 0.035 | 0.049 | |
| L4 | 0.60 | 1.00 | 0.024 | 0.039 | |
| L5 | 0.15 | 0.75 | 0.006 | 0.030 | |
| L6 | 1.80 | 1.80 REF | | REF | |
| Ф | 1.20 | 1.40 | 0.047 | 0.055 | |
| θ | 0° | 8° | 0° | 8° | |

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TO-251 Package Information



| Cumbal | Dimensions | In Millimeters | Dimensions In Inches | |
|--------|------------|----------------|----------------------|-------|
| Symbol | Min. | Max. | Min. | Max. |
| Α | 2.20 | 2.35 | 0.087 | 0.093 |
| A1 | 0.90 | 1.10 | 0.035 | 0.043 |
| b | 0.56 | 0.69 | 0.022 | 0.027 |
| b1 | 0.77 | 0.90 | 0.030 | 0.035 |
| b2 | 5.23 | 5.43 | 0.206 | 0.214 |
| b3 | | 1.05 | 0.000 | 0.041 |
| С | 0.46 | 0.59 | 0.018 | 0.023 |
| c1 | 0.46 | 0.59 | 0.018 | 0.023 |
| D | 6.00 | 6.20 | 0.236 | 0.244 |
| D1 | 5.20 | | 0.205 | |
| E | 6.50 | 6.70 | 0.256 | 0.264 |
| E1 | 4.60 | 5.00 | 0.181 | |
| e | 2.24 | 2.34 | 0.088 | 0.092 |
| e1 | 4.47 | 4.67 | 0.176 | 0.184 |
| Н | 16.18 | 16.78 | 0.637 | 0.661 |
| L | 9.00 | 9.60 | 0.354 | 0.378 |
| L1 | 0.95 | 1.35 | 0.037 | 0.053 |
| L2 | 0.90 | 1.25 | 0.035 | 0.049 |

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NCE65T2K4I, NCE65T2K4K

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DMN2990UFB-7B SSM3K35CT,L3F IPLK60R1K0PFD7ATMA1 2N7002W-G MCAC30N06Y-TP IPWS65R035CFD7AXKSA1
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